

## Features

- 0.3x0.6x 0.2mm SMD LED
- High Brightness
- InGaN Technology
- Small package
- High reliability
- Clear Lens

## Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

## Description

The IN-S21ST5G is a popular low profile CSP package with versatile design capabilities. It is a CSP type molding style LED which can be used in various applications.

## Recommended Solder Pattern

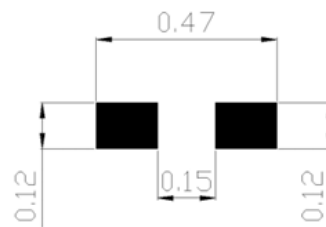
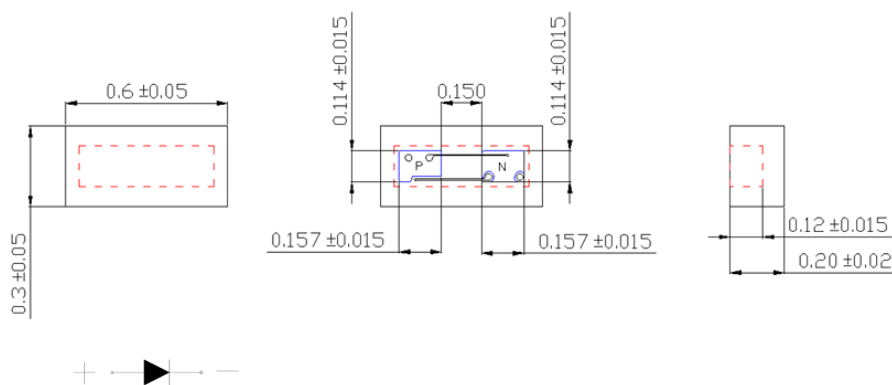


Figure 1. IN-S21ST5G Solder Pattern

## Package Dimensions in mm



### Notes.

1. All dimensions are in millimeters.
2. Tolerance is  $\pm 0.05$  mm unless otherwise noted

Figure 2. IN-S21ST5G Package Dimensions

### Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	$P_d$ (mW)	$I_F$ (mA)	$I_{FP}^*$ (mA)	$V_R$ (V)	$T_{OP}$ (°C)	$T_{ST}$ (°C)
IN-S21ST5G	Green	56	20	50	5	-30°C~+85°C	-40°C~+85°C

### Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

### ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

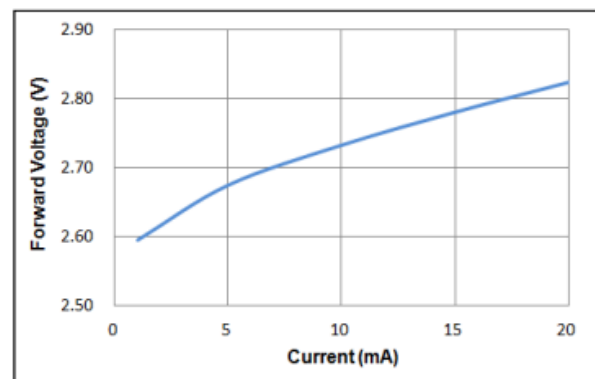
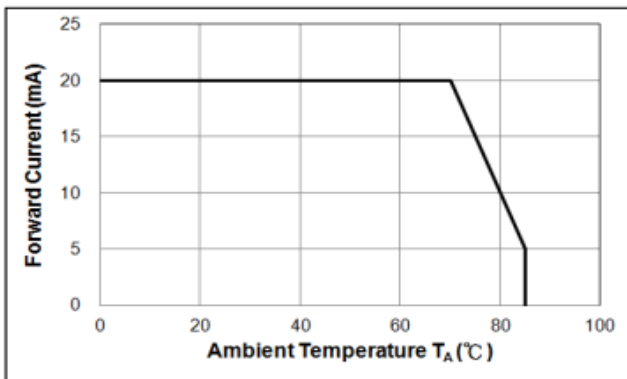
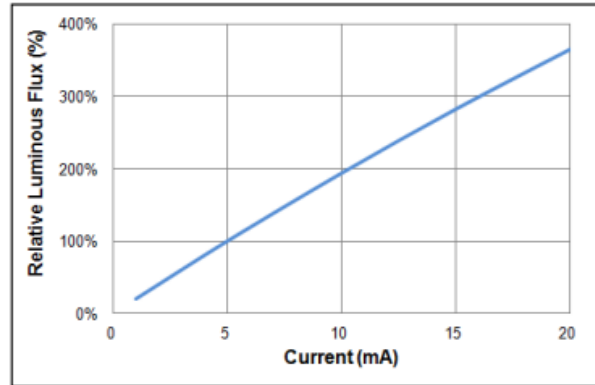
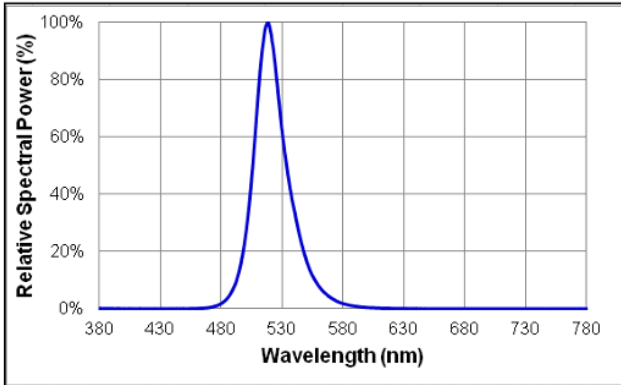
**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  (Note 1)

Product	Emission Color	$I_F(\text{mA})$	$V_F(\text{V})$		$\lambda$ (nm)			Viewing Angle	$I^*_V(\text{mcd})$
			min	max	$\lambda_D$	$\lambda_P$	$\Delta\lambda$	$2\theta_{1/2}$	typ.
IN-S21ST5G	Green	5	2.2	2.6	525	530	25	140	300

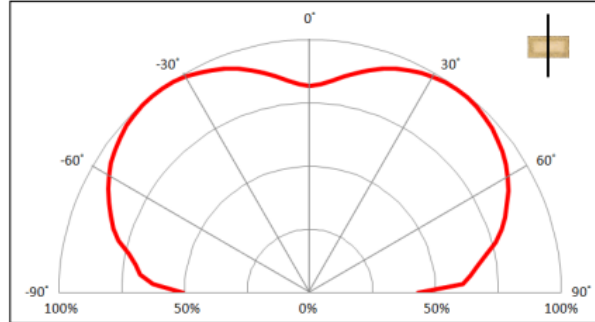
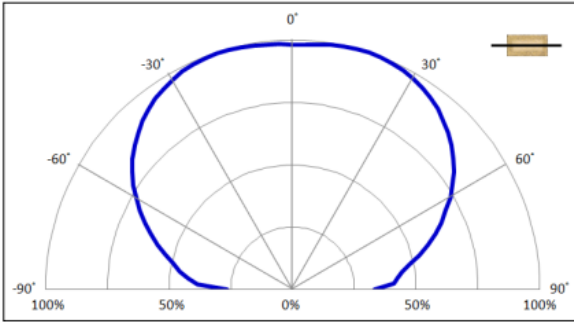
**Notes**

1. Performance guaranteed only under conditions listed in above tables.

## Typical Characteristic Curves



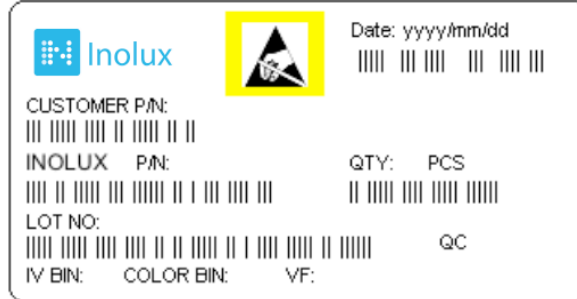
### Typical Characteristic Curves – Radiation Pattern



### Ordering Information

Product	Emission Color	Technology	Test Current $I_F$ (mA)	Luminous Intensity $I_V$ (mcd) (Typ.)	Forward Voltage $V_F$ (V) (Typ.)	Orderable Part Number
IN-S21ST5G	Green	InGaN	5	300	2.4	IN-S21ST5G

### Label Specifications



### Inolux P/N:

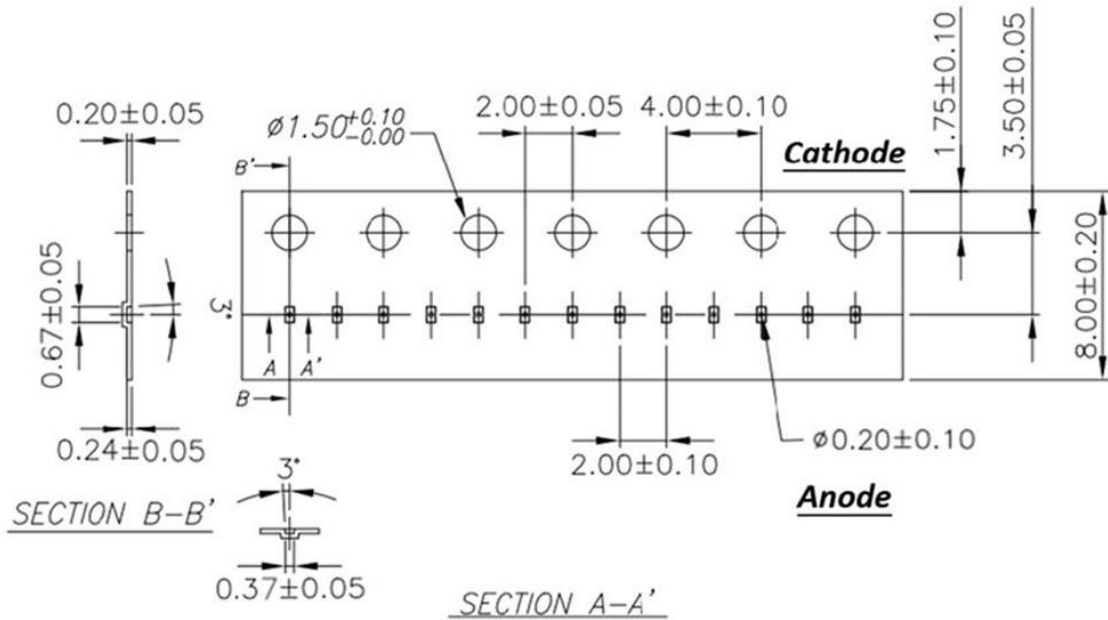
I	N	-	S	2	1	S	T	5		G	-	-	-	-	-	
			Material	Package		Variation	Orientation	Current	Lens	Color		Customized Stamp-off				
Inolux SMD			S = PCB Type	21S = 0.6 x 0.3x 0.2mm			T = Top Mount	5=5mA	(Blank) = Clear U = Diffused	B=Green						

### Lot No.:

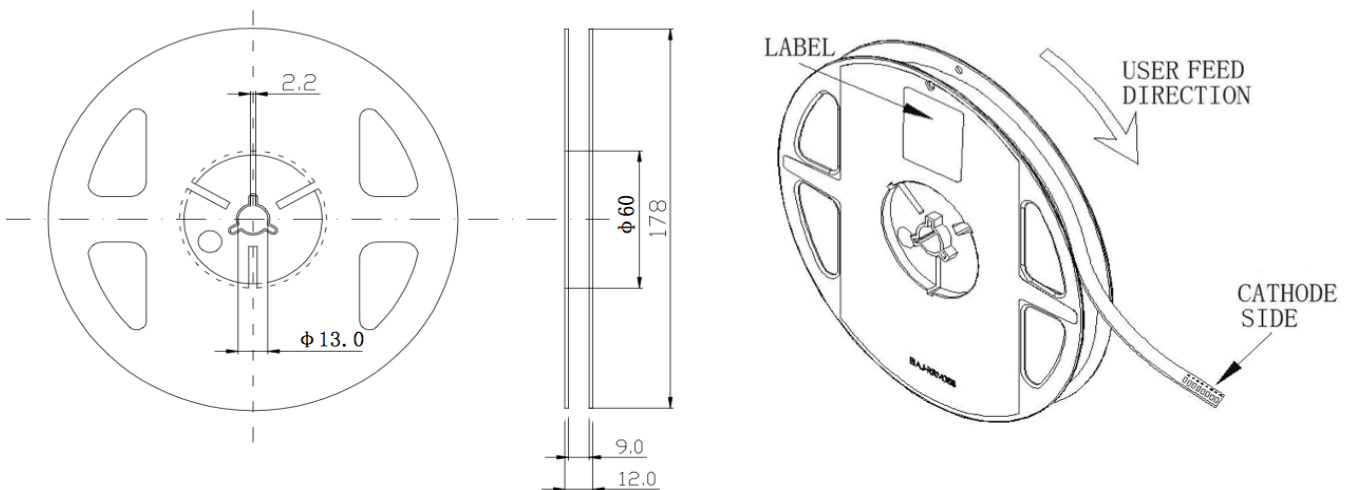
Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018, .....)				Month	Date	Serial

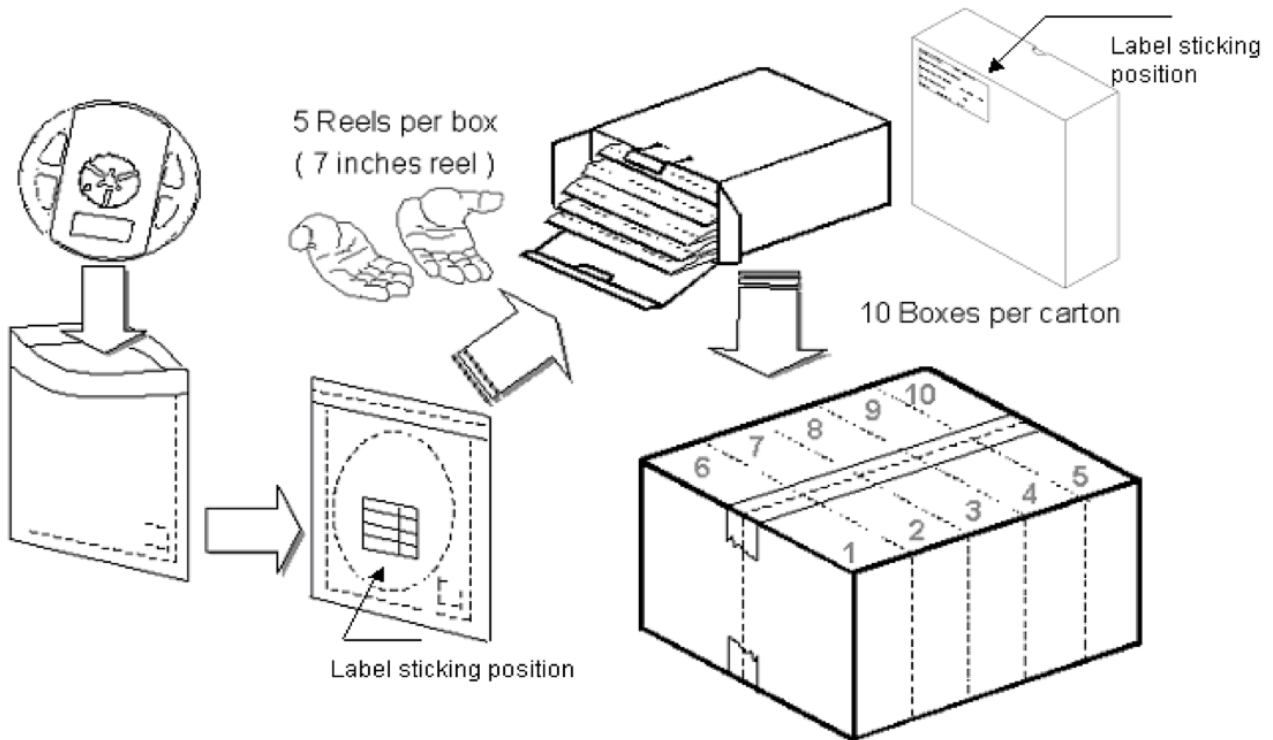
**Packaging Information: 4000pcs Per Reel**

**Tape Dimension**



**Reel Dimension**



**Packing Dimension**


5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

**Others:**

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of  $I_v$ ,  $\lambda_D$  and  $V_f$ . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

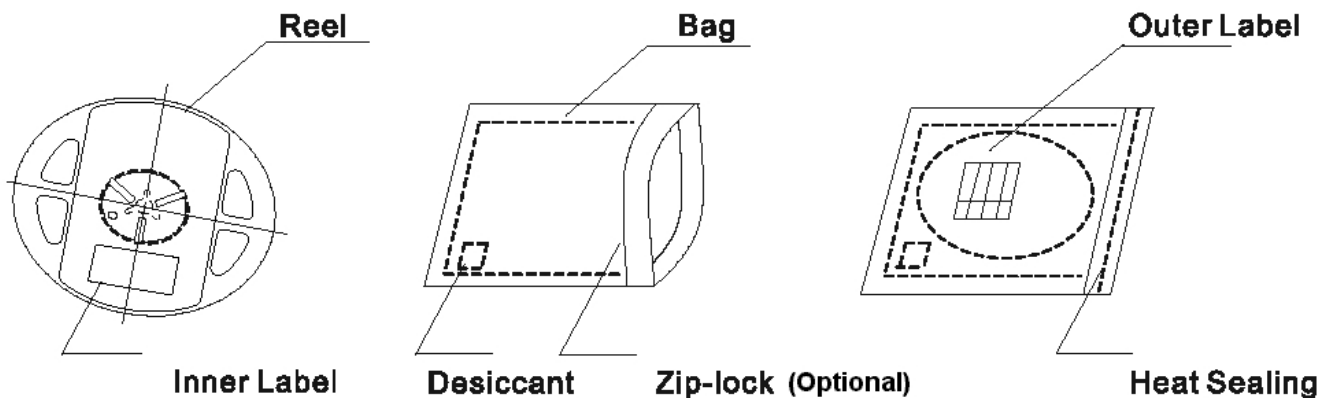


## Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

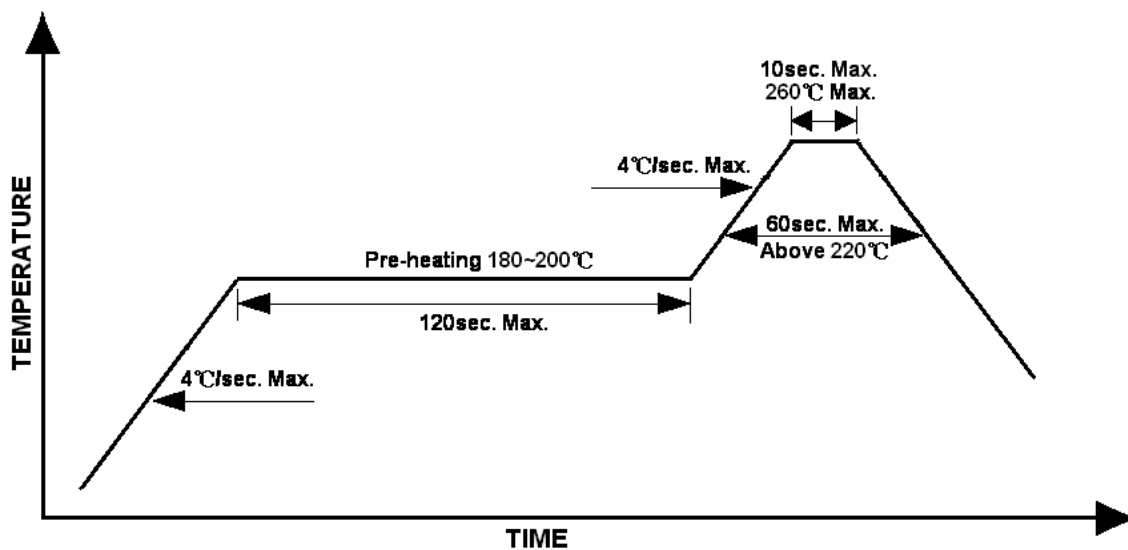
The packaging sequence is as follows:



## Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile



## Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

## Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

## Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

## Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

## Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	03-27-2024

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